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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/829,583	04/22/2004	Hsuch-Chung Chen	252011-2240	6746	
47390 7590 06/14/2007 THOMAS, KAYDEN, HOSTEMEYER & RISLEY LLP			EXAM	EXAMINER	
100 GALLERIA PARKWAY			ANDUJAR, LEONARDO		
SUITE 1750 ATLANTA, G	A 30339	·	ART UNIT	PAPER NUMBER	
,				2826	
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			MAIL DATE	DELIVERY MODE	
		4.	06/14/2007	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)			
	10/829,583	CHEN ET AL.			
Office Action Summary	Examiner	Art Unit			
	Leonardo Andújar	2826			
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address			
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be ting within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).			
Status					
 Responsive to communication(s) filed on 3/23/2007. This action is FINAL. 2b) This action is non-final. Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213. 					
Disposition of Claims	,				
4) Claim(s) 1-12 and 14-21 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 5) Claim(s) is/are allowed. 6) Claim(s) 1-12 and 14-21 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement.					
Application Papers					
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) accomplicated may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Examine	epted or b) objected to by the lddrawing(s) be held in abeyance. See ion is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).			
Priority under 35 U.S.C. § 119					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 					
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:				

DETAILED ACTION

Acknowledgment

1. The amendment filed on 03/23/2007 in response to the Office action mailed on 2/21/2007 has been entered. The present Office action is made with all the suggested amendments being fully considered. Accordingly, pending in this Office action are claims 1-12 and 14-21.

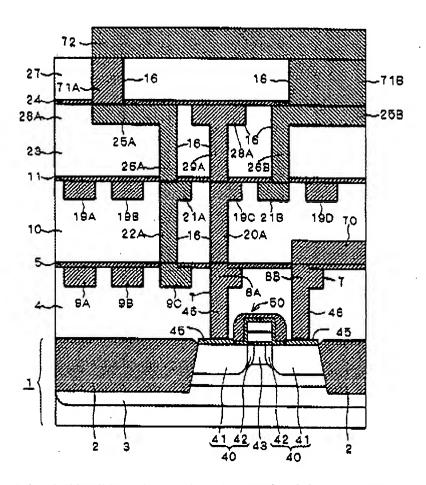
Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 3. Claims 1, 3-6, 8-12, 14, 15 and 17-21 are rejected under 35 U.S.C. 102(e) as being anticipated by Kunikiyo (US 6,717,267).
- 4. Regarding claim 1, Kunikiyo (e.g. fig. 15) shows a semiconductor configuration for dissipating heat away from a semiconductor device having a plurality of power bus lines, comprising: a semiconductor substrate 1, an insulating layer 4/10 disposed above the semiconductor substrate; a power line (72/71AB/25AB/26AB) with a plurality of openings and a plurality of interconnect structures (28A/29A/19C/20/6A/46/45) with at least one pair of vertical portions 46/20A disposed in the insulating layer and a horizontal portions 28A disposed within the plurality of openings and above the

insulating layer, each of the vertical portions having a first end 46/45 in contact with the semiconductor substrate and a second end substantially level with the power line (28A same level than 25AB) semiconductor device, wherein the interconnect structures for dissipating heat through the substrate and further wherein the horizontal portion of the plurality of interconnection structures is substantially enveloped by a dielectric layer 23/24/27 in the openings of the power line (col. 9/lls. 1-6 & col. 201/lls. 24-23).



5. Regarding claim 3, Kunikiyo shows that the each of the plurality of interconnects structures comprises at least one via stack.

6. Regarding claim 4, Kunikiyo shows that the plurality of interconnects structures are close to the power line.

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- 7. Regarding claim 5, Kunikiyo shows that at least one of the plurality of interconnect structure is joined to one other of the plurality of interconnect structures using a bridge structure. Note that trenches (e.g. 28A) joint a plurality of vias using a bridge structure (i.e. z direction).
- 8. Regarding claim 6, Kunikiyo shows bridge structures (i.e. 28A and 29A), each of the bridge structures joins a respective one of the plurality of interconnect structures to one other of the plurality of interconnect structures. Note that trenches (e.g. 28A) joint a plurality of vias using a bridge structure (i.e. z direction).
- 9. Regarding claims 8, 14, 17 and 19, Kunikiyo shows that the interconnect structures (29A, 20A) are alternatively spaced apart form each other by width of one of the interconnect structures (e.g. 19C).
- 10. Regarding claim 9, Kunikiyo shows that the plurality of interconnects structure (e.g. 26a) is alternatively spaced apart form a serpentine power line 25a by a distance (e.g. fig. 9).
- 11. Regarding claim 10, Kunikiyo shows that the distance is a width of one of the plurality of interconnect structures (e.g. width of one via hole).
- 12. Regarding claim 11 and 12, Kunikiyo shows that each of the interconnect structures (28A) is spaced apart from a power line 72 by a distance (e.g. 71B).

13. Regarding claim 15, Kunikiyo shows that the ratio of width of one of the interconnect structures to the power line is between about 1 to about 20. Note that the lines and the power lines are identical.

- 14. Regarding claim 18, Kunikiyo shows that the each of the plurality of structures is alternatively spaced apart within the power line by a distance.
- 15. Regarding claim 20, Kunikiyo shows that the power line has a serpentine shape (e.g. fig. 9).
- 16. Regarding claim 21, Kunikiyo shows that the power line has a liner shape in the depth direction (e.g. fig. 12).

Claim Rejections - 35 USC § 103

- 17. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 18. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

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19. Claim 7 and 16 are rejected under 35 U.S.C. 103(a) as being unpatentable over

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Kunikiyo (US 6,717,267).

20. Regarding claims 7 and 16, Kunikiyo teaches most aspects of the instant

invention including an interconnection structure having a width (i.e., design variable col.

15/lls. 24-41), but does not disclose that the interconnect structure is from about 0.1 to

10 micrometers. Nonetheless, the specification contains no disclosure of either the

critical nature of the claimed arrangement or any unexpected results arising therefrom.

Where patentability is said to be based upon particular chosen dimensions or upon

another variable recited in a claim, the applicant must show that the chosen dimensions

are critical. In re Woodruff, 919 F.2d 1575, 1578, 16 USPQ2d 1934, 1936 (Fed. Cir.

1990). Also, the specific width claimed by applicant, i.e., from about 0.1 to 10

micrometers, absent any criticality, is only considered to an optimum value of the

interconnect width structure disclosed by the Prior Art that a person having ordinary skill

in the art would have been able to determine using routine experimentation based,

among other things, on the desired accuracy, manufacturing costs, etc. (see In re-

Boesch, 205 USPQ 215 (CCPA 1980)), and since neither non-obvious nor unexpected

results, i.e., results which are different in kind and not in degree from the results of the

prior art, will be obtained as long as an interconnect structure is used as already

suggested by the Prior Art.

21. Claims 2 is rejected under 35 U.S.C. 103(a) as being unpatentable over Kunikiyo

(US 6,717,267) in view of Khan et al. (US 6,853,070).

22. Regarding claim 2, Kunikiyo shows most aspects of the instant invention including a substrate but does not disclose a heat sink in contact with the substrate. Nevertheless, Khan (e.g. fig. 2A) shows a mounting structure including a heat sink 110/134 in contact with the substrate 102. According to Kahn this type of mounting structure provides an improved thermal, mechanical and electrical performance because the thermal stress is reduced due to a matched thermal coefficient (col. 1/lls. 52-67; col. 2/lls. 1-6 and col. 3/lls. 14-21). It would have been obvious to one of ordinary skill in the art at the time the invention was made to mount the device disclosed by Kunikiyo in the mounting structure disclosed by Khan which includes a heat sink in contact with the substrate to provide a semiconductor package having a reduce thermal stress in order to improve the thermal, mechanical and electrical performance of the package.

Response to Arguments

- 23. Applicant's arguments filed 11/08/2006 have been fully considered but they are not persuasive.
- Applicant argues that the new added limitations are not taught by the prior art. However, Kunikiyo teaches the power line include a plurality of openings. As shown in figure 9 the power line includes parallel structures including openings (i.e. plurality of parallel inverted U). The inner areas are recognized as the plurality of openings. Also, the interconnections include a pair of vertical portions 46/20A (i.e. vias) and horizontal portions 28A (i.e. trenches) disposed within the plurality of openings and above the

insulating layer wherein the horizontal portion is enveloped by a dielectric layer 23/24/27 in the openings of the power line.

Conclusion

25. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

26. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Leonardo Andújar whose telephone number is 571-272-1912. The examiner can normally be reached on Mon through Thu from 9:00 AM to 7:30 PM EST.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Sue Purvis can be reached on 571-272-1236. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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system, call 800-786-9199 (IN USA OR CANADA) or 571-272/1000/

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